

# Switching Regulator IC for Boost Converter

Current Mode Control with 45V/1.75A MOSFET

#### ■FEATURES

- Current Mode Control
- External Clock Synchronization
- Wide Operating Voltage Range 4.55V to 40V
- Switching Current 1.75A min.
- PWM Control
- Built-in Compensation Circuit
- Correspond to Ceramic Capacitor (MLCC)
- Oscillating Frequency 2.0MHz typ. (C ver.)
- Soft Start Function 10ms typ.
- UVLO (Under Voltage Lockout)
- Over Current Protection (Hiccup type)
- Thermal Shutdown Protection
- Standby Function
- AEC-Q100

This product meets the reliability level required by AEC-Q100.

Package Outline NJW4132U2 : SOT-89-5-2

#### ■GENERAL DESCRIPTION

The **NJW4132** is a boost converter with 45V/1.75A MOSFET. It corresponds to high oscillating frequency and Low ESR Output Capacitor (MLCC) within wide input range from 4.5V to 40V.

Therefore, the **NJW4132** can realize downsizing of applications with a few external parts so that adopts current mode control.

Also, it has a soft start function, external clock synchronization, over current protection and thermal shutdown circuit.

### ■APPLICATION

- Automotive
- Factory automation

#### ■BLOCK DIAGRAM



## ■PRODUCTS INFORMATION

PART NUMBER	VERSION	FREQUENCY	PACKAGE	Operating Temperature Range
NJW4132U2-A	А	300kHz typ.	SOT-89-5-2	General SPEC : -40 to +85°C
NJW4132U2-B	В	700kHz typ.	SOT-89-5-2	General SPEC : -40 to +85°C
NJW4132U2-C	С	2.0MHz typ.	SOT-89-5-2	General SPEC : -40 to +85°C
NJW4132U2-C-T1	C	2.0MHz typ.	SOT-89-5-2	Automotive SPEC : -40 to +125°C

This data sheet is applied to "NJW4132U2-C-T1".

Please refer to each data sheet for other versions.

### ■PIN CONFIGURATION



PIN NO.	SYMBOL	DESCRIPTION
1	SW	Switch Output Pin
2	GND	Ground Pin
3	IN-	Output Voltage Detect Pin
4	EN/SYNC	Standby Control/External crook synchronization Pin
5	V <sup>+</sup>	Power Supply Pin

### ■MARK INFORMATION



### **■ORDERING INFORMATION**

PART NUMBER	PACKAGE OUTLINE	RoHS	HALOGEN- FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ(pcs)
NJW4132U2-C-T1	SOT-89-5-2	Yes	Yes	Sn2Bi	441	61	1,000

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### ■ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	MAXIMUM RATINGS	UNIT
Supply Voltage	V*	+45	V
SW pin Voltage	V <sub>SW</sub>	+45	V
IN- pin Voltage	V <sub>IN-</sub>	-0.3 to +6	V
EN/SYNC pin Voltage	V <sub>EN/SYNC</sub>	+45	V
Rower Discinction	р	625 (*1)	m\//
Power Dissipation	۳D	2,400 (*2)	TIVV
Junction Temperature Range	Tj	-40 to +150	°C
Operating Temperature Range	T <sub>opr</sub>	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

(\*1): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 2Layers)

(\*2): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 4Layers)

(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hall to a board based on JEDEC standard JESD51-5)

# ■RECOMMENDED OPERATING CONDITIONS

(Ta=-40°C to +125°C)

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V*	4.55	-	40	V
External Clock Input Range	f <sub>SYNC</sub>	1,800	-	2,400	kHz

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Ver.1



ELECTRICAL CHARACTERIS	(Unless otherw	(Unless otherwise noted, $V^+=V_{EN/SYNC}=12V$ , Ta=25°C)					
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Under Voltage Lockout Block							
ON Threshold Voltage		$V^+ = L \rightarrow H$	4.20	4.35	4.50		
, i i i i i i i i i i i i i i i i i i i	V <sub>T_ON</sub>	$V^+$ = L $\rightarrow$ H, Ta=-40°C to +125 °C	4.20	_	4.53	V	
OFF Threshold Voltage		$V^+ = H \rightarrow L$	4.10	4.25	4.40		
	V <sub>T_OFF</sub>	$V^+$ = H $\rightarrow$ L, Ta=-40°C to +125 °C	4.10	-	4.43	V	
Hysteresis Voltage	V <sub>HYS</sub>		70	100	_	mV	
Soft Start Block							
Coff Start Time		V <sub>B</sub> =0.95V	5	10	15		
	ISS	V <sub>B</sub> =0.95V, Ta=-40°C to +125 °C	5	Ι	16	1115	
Oscillator Block							
		V <sub>IN-</sub> =0.9V	1.82	2.0	2.2		
Oscillation Frequency	f <sub>OSC</sub>	V <sub>IN</sub> =0.9V, Ta=-40⁰C to +125 ⁰C	1.77	-	2.2	MHz	
Oscillation Frequency OCP operates	f <sub>OSC_LIM</sub>	V <sub>IN</sub> =0.4V	-	410	_	kHz	
Oscillation Frequency deviation (Supply voltage)	f <sub>DV</sub>	V <sup>+</sup> =4.5V to 40V	_	1	_	%	
Error Amplifier Block							
	V		-1.0%	1.0	+1.0%	V	
Relefence vollage	ν <sub>B</sub>	Ta=-40°C to +125 °C	-2.0%	Ι	+2.0%	v	
Input Bias Current			-0.1	_	0.1	Δ	
	чВ	Ta=-40°C to +125 °C	-0.1	_	0.1	μΑ	
PWM Comparate Block							
		V <sub>IN-</sub> =0.9V	80	85	-		
Maximum Duty Cycle	M <sub>AX</sub> D <sub>UTY</sub>	V <sub>IN</sub> =0.9V, Ta=-40⁰C to +125 ⁰C	80	-	_	%	
Minimum ON Time1	+		-	80	_	<b>DC</b>	
(Use Built-in Oscillator)	<sup>L</sup> ON-min1	Ta=-40°C to +125 °C	_	_	120	115	
Minimum ON Time2		f <sub>SYNC</sub> =2.2MHz	-	80	_		
(Use Ext CLK)	t <sub>ON-min2</sub>	f <sub>SYNC</sub> =2.2MHz, Ta=-40⁰C to +125 ⁰C	-	-	120	ns	
OCP Block							
COOL DOWN Time	t <sub>COOL</sub>		_	42	—	ms	
Output Block							
Output ON Resistance	R <sub>ON</sub>	I <sub>SW</sub> =1A	_	0.4	0.65	Ω	
Switching Current Limit	I <sub>LIM</sub>		1.75	2.1	2.25	Α	
SW Leak Current	I <sub>LEAK</sub>	V <sub>EN/SYNC</sub> =0V, V <sub>SW</sub> =45V	_	_	1	μA	

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■ELECTRICAL CHARACTERISTICS		(Unless otherwise noted, V <sup>+</sup> =V <sub>EN/SYNC</sub> =12V, Ta=25°C)				
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Standby Control Block						
		$V_{EN/SYNC} = L \longrightarrow H$	1.6	—	V*	
ON Control Voltage	V <sub>ON</sub>	$V_{EN/SYNC} = L \rightarrow H$ , Ta=-40°C to +125 °C	1.6	-	V⁺	V
		$V_{\text{EN/SYNC}} = H \longrightarrow L$	0	_	0.5	
OFF Control Voltage V <sub>OFF</sub>		$V_{EN/SYNC}$ = H $\rightarrow$ L, Ta=-40°C to +125 °C	0	_	0.5	V
Input Pice Current		V <sub>EN/SYNC</sub> =12V	_	250	400	μΑ
(EN/SYNC pin)		V <sub>EN/SYNC</sub> =12V, Ta=-40°C to +125 °C	-	-	450	μA
General Characteristics						
		R <sub>L</sub> =no load, V <sub>IN</sub> =0.9V	_	3.5	4.0	
Quiescent Current	I <sub>DD</sub>	R <sub>L</sub> =no load, V <sub>IN</sub> =0.9V Ta=-40⁰C to +125 ⁰C	_	_	5.0	mA

### **THERMAL CHARACTERISTICS**

Standby Current

PARAMETER SYMBOL		VALUE	UNIT
Junction-to-ambient thermal resistance	θја	200 (*3) 52 (*4)	°C/W
Junction-to-Top of package characterization parameter	ψjt	43 (*3) 19 (*4)	°C /W

V<sub>EN/SYNC</sub>=0V

V<sub>EN/SYNC</sub>=0V, Ta=-40°C to +125 °C

(\*3): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 2Layers)

IDD\_STB

(\*4): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 4Layers)

(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hall to a board based on JEDEC standard JESD51-5)

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#### ■POWER DISSIPATION vs. AMBIENT TEMPERATURE



(\*5): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 2Layers)

(\*6): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 4Layers)

(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hall to a board based on JEDEC standard JESD51-5)

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#### ■TYPICAL CHARACTERISTICS



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### **TYPICAL CHARACTERISTICS**



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#### ■TYPICAL CHARACTERISTICS



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### ■ TYPICAL APPLICATIONS

# **Boost Converter**



#### Buck-Boost (SEPIC) Converter



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■APPLICATION MANUAL

### ■PIN DESCRIPTIONS

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PIN NUMBER	PIN NAME	FUNCTION
1	SW	Switch Output pin of Power MOSFET
2	GND	GND pin
3	IN-	Output Voltage Detecting pin Connects output voltage through the resistor divider tap to this pin in order to voltage of the IN- pin become 1.0V.
4	EN/SYNC	Standby Control pin The EN/SYNC pin internally pulls down with 100kΩ. Normal Operation at the time of High Level. Standby Mode at the time of Low Level or OPEN. Moreover, it operates by inputting clock signal at the oscillatory frequency that synchronized with the input signal.
5	V <sup>+</sup>	Power Supply pin for Power Line

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### ■DESCRIPTION OF BLOCK FEATURES

1. Basic Functions / Features

### • Error Amplifier Section (ER·AMP)

1.0V±1% precise reference voltage is connected to the non-inverted input of this section.

To set the output voltage, connects converter's output to inverted input of this section (IN- pin). If requires output voltage, inserts resistor divider.

Because the optimized compensation circuit is built-in, the application circuit can be composed of minimum external parts.

### • PWM Comparator Section (PWM), Oscillation Circuit Section (OSC)

The NJW4132 uses a constant frequency, current mode step up architecture. The oscillation frequency is 300 kHz (typ.) at A version, 700 kHz (typ.) at B version and 2.0MHz (typ.) at C version. The PWM signal is output by feedback of output voltage and slope compensation switching current at the PWM comparator block.

The maximum duty ratio is 90% (typ.) in A version and B version.

Minimum ON time is limited in the inside of the IC. (Table 1.)

### Table 1. Minimum ON time of NJW4132

	A version	B version	C version	
	(f <sub>OSC</sub> =300kHz)	(f <sub>OSC</sub> =700kHz)	(f <sub>OSC</sub> =2.0MHz)	
Use Built-in	300pst/p	110ps tvp	80ps tvp	
Oscillator	Soonstyp.	попатур.	oons typ.	
Use External	220nstyp.	90ns typ.	80ns typ.	
Clock	(@ f <sub>SYNC</sub> =400kHz)	(@ f <sub>SYNC</sub> =800kHz)	(@ f <sub>SYNC</sub> =2.2MHz)	

The boost converter of ON time is decided the following formula.

$$\operatorname{ton} = \left(1 - \frac{\mathsf{V}_{\mathsf{IN}}}{\mathsf{V}_{\mathsf{OUT}}}\right) \times \frac{1}{\mathsf{f}_{\mathsf{OSC}}} \left[\mathsf{s}\right]$$

 $V_{\text{IN}}$  shows input voltage and  $V_{\text{OUT}}$  shows output voltage.

When the ON time becomes below in t<sub>ON-min</sub>, in order to maintain output voltage at a stable state, change of duty or pulse skip operation may be performed.

### Power MOSFET (SW Output Section)

The power is stored in the inductor by the switch operation of built-in power MOSFET. The output current is limited to 1.75A (min.) the overcurrent protection function.

• Power Supply, GND pin (V<sup>+</sup> and GND)

In line with switching element drive, current flows into the IC according to frequency. If the power supply impedance provided to the power supply circuit is high, it will not be possible to take advantage of IC performance due to input voltage fluctuation. Therefore connect the input capacitor near V<sup>+</sup> pin – the GND pin. When an IC and an input capacitor are far, insert bypass capacitor generally  $0.1\mu$ F, and lower the high frequency impedance.

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### ■DESCRIPTION OF BLOCK FEATURES (Continued)

- 2. Additional and Protection Functions / Features
  - Under Voltage Lockout (UVLO)

The UVLO circuit operating is released above V<sup>+</sup>=4.35V (typ.) and IC operation starts. When power supply voltage is low, IC does not operate because the UVLO circuit operates. There is 100mV (typ.) width hysteresis voltage at rise and decay of power supply voltage. Hysteresis prevents the malfunction at the time of UVLO operating and releasing.

Soft Start Function (Soft Start)

The output voltage of the converter gradually rises to a set value by the soft start function. The soft start time is 10ms (typ.). It is defined with the time of the error amplifier reference voltage becoming from 0V to 0.95V. The soft start circuit operates after the release UVLO and/or recovery from thermal shutdown.



Fig. 1. Startup Timing Chart

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### DESCRIPTION OF BLOCK FEATURES (Continued)

Over Current Protection Circuit (OCP)

NJW4132 contains overcurrent protection circuit of hiccup architecture. The overcurrent protection circuit of hiccup architecture is able to decrease heat generation at the overload.

The NJW4132 output returns automatically along with release from the over current condition.

At when the switching current becomes  $I_{LIM}$  or more, the overcurrent protection circuit is stopped the MOSFET output. The switching output holds low level down to next pulse output at OCP operating.

When IN- pin voltage becomes 0.75V or less, it oscillation frequency decreases to approximately 17%

At the same time starts pulse counting, and stops the switching operation when the overcurrent detection continues approx 7ms (@ A ver.), 5ms (@ B ver.) and 2ms (@C ver.).

After NJW4132 switching operation was stopped, it restarts by soft start function after the cool down time of approx 42ms (typ.).



Fig. 2. Timing Chart at Over Current Detection

• Thermal Shutdown Function (TSD)

When Junction temperature of the NJW4132 exceeds the 160°C\*, internal thermal shutdown circuit function stops SW function. When junction temperature decreases to 145°C\* or less, SW operation returns with soft start operation.

The purpose of this function is to prevent malfunctioning of IC at the high junction temperature. Therefore it is not something that urges positive use. You should make sure to operate within the junction temperature range rated (150°C). (\* Design value)

Standby Function

The NJW4132 stops the operating and becomes standby status when the EN/SYNC pin becomes less than 0.5V.

The EN/SYNC pin internally pulls down with 100k $\Omega$ , therefore the NJW4132 becomes standby mode when the EN/SYNC pin is OPEN. You should connect this pin to V<sup>+</sup> when you do not use standby function.

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External Clock Synchronization

By inputting a square wave to EN/SYNC pin, can be synchronized to an external frequency. You should fulfill the following specification about a square wave. (Table 2.)

Table 2. The input square wave to an EN/SYNC pin.

	A version	B version	C version	
	(f <sub>OSC</sub> =300kHz)	(f <sub>OSC</sub> =700kHz)	(f <sub>OSC</sub> =2.0MHz)	
	290kHz to	690kHz to	1.8MHz to	
Input Frequency	500kHz	1,000kHz	2.4MHz	
Duty Cycle	20% to 80%	35% to 65%	40% to 60%	
Voltage	1.6V or more at High level			
magnitude	0.5V or less at Low level			

The trigger of the switching operating at the external synchronized mode is detected to the rising edge of the input signal. At the time of switching operation from standby or asynchronous to synchronous operation, it has set a delay time approx  $20\mu$ s to  $30\mu$ s (@ A ver.),  $10\mu$ s to  $20\mu$ s (@ B ver.) and  $3\mu$ s to  $8\mu$ s (@ C ver.) in order to prevent malfunctions. (Fig. 3.)



Fig. 3. Switching Operation by External Synchronized Clock

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### ■APPLICATION NOTE

#### Inductors

Because a large current flows to the inductor, you should select the inductor with the large current capacity not to saturate. Optimized inductor value is determined by the input voltage and output voltage.

The Optimized inductor value: (It is a reference value.)

$$V_{\text{IN}} = 5V \rightarrow V_{\text{OUT}} = 12V \qquad \qquad : L < = 10 \mu H$$

You should set the inductor as a guide from above mentioned value to half value.

Reducing L decreases the size of the inductor. However a peak current increases and adversely affects the efficiency. (Fig. 4.)

Moreover, you should be aware that the output current is limited because it becomes easy to operating to the overcurrent limit.

The peak current is decided the following formula.

$$I_{\rm IN} = \frac{V_{\rm OUT} \times I_{\rm OUT}}{\eta \times V_{\rm IN}} [A]$$

$$\Delta I_{L} = \frac{(V_{OUT} - V_{IN}) \times V_{IN}}{L \times V_{OUT} \times f_{OSC}} [A]$$

$$lpk = l_{IN} + \frac{\Delta l_{L}}{2} [A]$$



Fig. 4. Inductor Current State Transition (Continuous Conduction Mode)

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#### ■APPLICATION NOTE (Continued)

### Catch Diode

When the switch element is in OFF cycle, power stored in the inductor flows via the catch diode to the output capacitor. Therefore during each cycle current flows to the diode in response to load current. Because diode's forward saturation voltage and current accumulation cause power loss, a Schottky Barrier Diode (SBD), which has a low forward saturation voltage, is ideal.

An SBD also has a short reverse recovery time. If the reverse recovery time is long, through current flows when the switching transistor transitions from OFF cycle to ON cycle. This current may lower efficiency and affect such factors as noise generation.

When the switch element is in ON cycle, a reverse voltage flows to SBD. Therefore you should select a SBD that has reverse voltage rating greater than maximum output voltage. The power loss, which stored in output capacitor, will be increase due to increasing reverse current through SBD at high temperature. Therefore, there are cases preferring reverse current characteristics to forward current characteristic in order to improve efficiency.

### Input Capacitor

Transient current flows into the input section of a switching regulator responsive to frequency. If the power supply impedance provided to the power supply circuit is large, it will not be possible to take advantage of the NJW4132 performance due to input voltage fluctuation. Therefore insert an input capacitor as close to the MOSFET as possible.

### Output Capacitor

An output capacitor stores power from the inductor, and stabilizes voltage provided to the output. Because NJW4132 corresponds to the output capacitor of low ESR, the ceramic capacitor is the optimal for compensation.

The Optimized capacitor value: (It is a reference value.)  $V_{OLT} = 12V$  :  $C_{OLT} > = 22\mu F$ 

In addition, you should consider varied characteristics of capacitor (a frequency characteristic, a temperature characteristic, a DC bias characteristic and so on) and unevenness peculiar to a capacitor supplier enough.

Therefore when selecting a capacitors, you should confirm the characteristics with supplier datasheets.

When selecting an output capacitor, you must consider Equivalent Series Resistance (ESR) characteristics, ripple current, and breakdown voltage.

The output ripple noise can be expressed by the following formula.

 $V_{ripple(p-p)} = ESR \times \Delta I_L [V]$ 

The effective ripple current that flows in a capacitor  $(I_{ms})$  is obtained by the following equation.

$$I_{\rm rms} = \sqrt{I_{\rm PK}^2 - I_{\rm OUT}^2} \, [\rm Arms]$$

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### ■APPLICATION NOTE (Continued)

• Setting Output Voltage, Compensation Capacitor

The output voltage  $V_{OUT}$  is determined by the relative resistances of R1, R2. The current that flows in R1, R2 must be a value that can ignore the bias current that flows in ER AMP.

$$V_{\text{OUT}} = \left(\frac{\text{R2}}{\text{R1}} + 1\right) \times V_{\text{B}} \text{ [V]}$$

The zero points are formed with R2 and  $C_{FB}$ , and it makes for the phase compensation of NJW4132. The zero point is shown the following formula.

$$\mathbf{f}_{z_1} = \frac{1}{2 \times \pi \times \mathbf{R} 2 \times \mathbf{C}_{\mathsf{FB}}} [\mathsf{Hz}]$$

You should set the zero point as a guide from 20 kHz to 60 kHz. Please optimize  $C_{FB}$  by application.

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### ■EVALUATION BOARD · PCB LAYOUT

### Board Layout

In the switching regulator application, because the current flow corresponds to the oscillation frequency, the substrate (PCB) layout becomes an important.

You should attempt the transition voltage decrease by making a current loop area minimize as much as possible. Therefore, you should make a current flowing line thick and short as much as possible. Fig.5. shows a current loop at Boost converter.



Fig. 5. Current Loop at Boost Converter

Concerning the GND line, it is preferred to separate the power system and the signal system, and use single ground point.

The voltage sensing feedback line should be as far away as possible from the inductance. Because this line has high impedance, it is laid out to avoid the influence noise caused by flux leaked from the inductance.

Fig. 6. Shows example of wiring at boost converter. Fig. 7. Shows the PCB layout example.



Fig. 6. Board Layout at Boost Converter

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### ■EVALUATION BOARD · PCB LAYOUT (Continued)



Connect Signal GND line and Power GND line on backside pattern

Fig. 7. Layout Example (upper view)

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### **■CALCULATION OF PACKAGE POWER**

A lot of the power consumption of boost converter occurs from the internal switching element (Power MOSFET). Power consumption of NJW4132 is roughly estimated as follows.

Input Power:	$P_{IN} = V_{IN} \times I_{IN}  [W]$
Output Power:	$P_{OUT} = V_{OUT} \times I_{OUT}  [W]$
Diode Loss:	$P_{\text{DIODE}} = V_{\text{F}} \times I_{\text{L(avg)}} \times \text{OFF duty}  [W]$
NJW4132 Power Consumption:	$P_{LOSS} = P_{IN} - P_{OUT} - P_{DIODE}  [W]$

Where:

V <sub>IN</sub>	: Input Voltage for Converter	I <sub>IN</sub>	: Input Current for Converter
V <sub>OUT</sub>	: Output Voltage of Converter	I <sub>OUT</sub>	: Output Current of Converter
$V_{F}$	: Diode's Forward Saturation Voltage	I <sub>L(avg)</sub>	: Inductor Average Current
OFF duty	: Switch OFF Duty Cycle		

Efficiency  $(\eta)$  is calculated as follows.

 $\eta = (P_{OUT} \div P_{IN}) \times 100 \text{ [\%]}$ 

You should consider temperature derating to the calculated power consumption: P<sub>D</sub>.

You should design power consumption in rated range referring to the power dissipation vs. ambient temperature characteristics (Fig. 8).

NJW4132U2 (SOT89-5-2 Package), Power Dissipation vs. Ambient Temperature (Topr= -40 to +125°C, Tjmax=150°C)



(\*7): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 2Layers)

(\*8): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JDEC standard, 4Layers)

(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hall to a board based on JEDEC standard JESD51-5)

Fig. 8. Power Dissipation vs. Ambient Temperature Characteristics

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# ■APPLICATION DESIGN EXAMPLES

- Boost Converter Application Circuit
  - IC
     : NJW4132U2-B

     Input Voltage
     : V<sub>IN</sub>=5V
    - Output Voltage : V<sub>OUT</sub>=12V
    - Output Current : I<sub>OUT</sub>=400mA
    - Oscillation frequency : fosc=700kHz



Reference	Qty.	Part Number	Description	Manufacturer
IC	1	NJW4132U2-B	Internal 45V MOSFET SW.REG. IC	New JRC
L	1	CDRH8D28HPNP-100N	Inductor 10µH, 3.4A	Sumida
SBD	1	CMS16	Schottky Diode 40V, 3A	Toshiba
C <sub>IN</sub>	1	10μF	Ceramic Capacitor 3225 10µF, 50V, X5R	Murata
C <sub>OUT</sub>	1	22µF	Ceramic Capacitor 3225 22µF, 16V, B	Murata
C <sub>FB</sub>	1	15pF	Ceramic Capacitor 1608 15pF, 50V, CH	Std.
R <sub>FB</sub>	1	$0\Omega$ (Short)	Optional	
R1	1	20kΩ	Resistor 1608 20kΩ, ±1%, 0.1W	Std.
R2	1	220kΩ	Resistor 1608 220kΩ, ±1%, 0.1W	Std.

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### ■APPLICATION CHARACTERISTICS



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# ■PACKAGE OUTLINE (SOT-89-5-2)







Unit:mm

# ■SOLDER FOOT PRINT (SOT-89-5-2)



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### **■PACKING SPECIFICATION**

NJRC delivers ICs in 4 methods, plastic tube container, two kinds of Taping, tray and vinyl bag packing. Except adhesive tape treated anti electrostatic and contain carbon are using as the ESD (Electrostatic Discharge Damage) protection.

SOT-89 Emboss Taping (TE1)

Symbol	SOT-89-3	SOT-89-5-1	SOT-89-5-2	Remark
А	4.9±0.1	4.8±0.1		Bottom size
В	4.5±0.1	4.9±0.1		Bottom size
D <sub>0</sub>	1.5+0.1/-0	1.5+0.1/-0		
E	1.5±0.1	1.6		
F	5.65±0.05	5.65±0.1		
P <sub>0</sub>	4.0±0.1	4.0±0.1		
P <sub>1</sub>	8.0±0.1	8.0±0.1		
P <sub>2</sub>	2.0±0.05	2.0±0.1		
Т	0.3±0.05	0.3±0.05		
T <sub>2</sub>	1.8	1.8		
W	12.0±0.3	12.0±0.3		

Unit: mm

Symbol	SOT-89-3	SOT-89-5-1	SOT-89-5-2	
А	Ø180±1			
В	Ø60±1			
С	Ø13±0.2			
D	Ø21±0.8			
E	2±0.5			
W	13±0.5			
W <sub>1</sub>	1.2±0.2			Unit: mm
Contents	1,000pcs			



Seal area by a cover tape





#### ■RECOMMENDED MOUNTING METHOD

#### INFRARED REFLOW SOLDERING METHOD



\*Recommended reflow soldering procedure

The temperature indicates at the surface of mold package.

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### **REVISION HISTORY**

DATE	REVISION	DESCRIPTION
2016/9/27	Ver.1	New Release

- New Japan Radio Co.,Ltd. -



# [CAUTION]

- 1. New JRC strives to produce reliable and high quality semiconductors. New JRC's semiconductors are intended for specific applications and require proper maintenance and handling. To enhance the performance and service of New JRC's semiconductors, the devices, machinery or equipment into which they are integrated should undergo preventative maintenance and inspection at regularly scheduled intervals. Failure to properly maintain equipment and machinery incorporating these products can result in catastrophic system failures
- 2. The specifications on this datasheet are only given for information without any guarantee as regards either mistakes or omissions. The application circuits in this datasheet are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights. All other trademarks mentioned herein are property of their respective companies.
- 3. To ensure the highest levels of reliability, New JRC products must always be properly handled. The introduction of external contaminants (e.g. dust, oil or cosmetics) can result in failures of semiconductor products.
- 4. New JRC offers a variety of semiconductor products intended for particular applications. It is important that you select the proper component for your intended application. You may contact New JRC's Sale's Office if you are uncertain about the products listed in this catalog.
- 5. Special care is required in designing devices, machinery or equipment which demands high levels of reliability. This is particularly important when designing critical components or systems whose failure can foreseeably result in situations that could adversely affect health or safety. In designing such critical devices, equipment or machinery, careful consideration should be given to amongst other things, their safety design, fail-safe design, back-up and redundancy systems, and diffusion design.
- 6. The products listed in the catalog may not be appropriate for use in certain equipment where reliability is critical or where the products may be subjected to extreme conditions. You should consult our sales office before using the products in any of the following types of equipment.

Aerospace Equipment Equipment Used in the Deep Sea Power Generator Control Equipment (Nuclear, Steam, Hydraulic) Life Maintenance Medical Equipment Fire Alarm/Intruder Detector Vehicle Control Equipment (airplane, railroad, ship, etc.) Various Safety devices

- 7. New JRC's products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this catalog. Failure to employ New JRC products in the proper applications can lead to deterioration, destruction or failure of the products. New JRC shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of its products. Products are sold without warranty of any kind, either express or implied, including but not limited to any implied warranty of merchantability or fitness for a particular purpose.
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- 9. The product specifications and descriptions listed in this catalog are subject to change at any time, without notice.



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